

L Number	Hits	Search Text	DB	Time stamp
2	4	(US-4753863-\$ or US-5360747-\$ or US-5329090-\$ or US-5962097-\$).did.	USPAT	2004/05/03 07:33
3	8	(US-6656820-\$ or US-6603191-\$ or US-6579748-\$ or US-6303471-\$ or US-5893760-\$ or US-3861969-\$ or US-5856230-\$).did. or (US-20020048906-\$).did.	USPAT; US-PGPUB	2004/05/03 09:29
4	150592	438/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/03 09:30
5	20	438/\$.ccls. and ((cvd) near2 resin)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/03 09:30
-	145829	438/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/11 10:20
-	46	438/\$.ccls. and ((stress near2 balanc\$4) near3 (layer or film or substrate))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/11 11:43
-	1	("6544655").PN.	USPAT	2003/12/10 13:13
-	2492	438/460-465.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/10 13:13
-	121	438/460-465.ccls. and warp\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/11 11:43
-	82	roman-angel.xa.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/10 14:16
-	2487	438/\$.ccls. and warp\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/10 14:48
-	840	(438/\$.ccls. and warp\$4) and (thinn\$4 or grind\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/10 14:49
-	251	((438/\$.ccls. and warp\$4) and (thinn\$4 or grind\$4)) and ((dicing or cutt\$4 or singulat\$4 or separat\$4) near4 wafer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/11 11:43
-	196	((438/\$.ccls. and warp\$4) and (thinn\$4 or grind\$4)) and ((dicing or cutt\$4 or singulat\$4 or separat\$4) near4 wafer) not (438/460-465.ccls. and warp\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/11 11:43

-	2471	438/113,114,460,464,465.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/11 10:37
-	1	438/113,114,460,464,465.ccls. and sbi	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/11 11:22
-	1327	438/113,114,460,464,465.ccls.	USPAT; US-PGPUB	2003/12/11 12:13
-	590	438/113,114,460,464,465.ccls. and (thinn\$4 or grind\$\$ or polish\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/11 11:40
-	628	438/113,114,460,464,465.ccls. and (thinn\$4 or grind\$\$ or polish\$4 or buf\$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/11 12:12
-	162	(438/113,114,460,464,465.ccls. and (thinn\$4 or grind\$\$ or polish\$4 or buf\$5)) and (warp\$4 or twist\$4 or deform\$6 or contort\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/11 11:42
-	179	((438/\$.ccls. and warp\$4) and (thinn\$4 or grind\$4)) and ((dicing or cutt\$4 or singulat\$4 or separat\$4) near4 wafer)) not (438/460-465.ccls. and warp\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/11 11:43
-	121	438/460-465.ccls. and warp\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/11 11:43
-	46	438/\$.ccls. and ((stress near2 balanc\$4) near3 (layer or film or substrate))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/11 11:43
-	83	((438/113,114,460,464,465.ccls. and (thinn\$4 or grind\$\$ or polish\$4 or buf\$5)) and (warp\$4 or twist\$4 or deform\$6 or contort\$4)) not (((438/\$.ccls. and warp\$4) and (thinn\$4 or grind\$4)) and ((dicing or cutt\$4 or singulat\$4 or separat\$4) near4 wafer)) not (438/460-465.ccls. and warp\$4)) or (438/460-465.ccls. and warp\$4) or (438/\$.ccls. and ((stress near2 balanc\$4) near3 (layer or film or substrate)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/11 12:13
-	906	438/460,464,465.ccls.	USPAT; US-PGPUB	2003/12/11 12:11
-	438	438/460,464,465.ccls. and (thinn\$4 or grind\$\$ or polish\$4 or buf\$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/11 12:12
-	437	438/460,464,465.ccls. and (thinn\$4 or grind\$4 or polish\$4 or buf\$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/11 12:14

-	1	(438/460,464,465.ccls. and (thinn\$4 or grind\$\$ or polish\$4 or buf\$5)) not (438/460,464,465.ccls. and (thinn\$4 or grind\$4 or polish\$4 or buf\$5))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/11 12:12
-	0	((438/460,464,465.ccls. and (thinn\$4 or grind\$\$ or polish\$4 or buf\$5)) not (438/460,464,465.ccls. and (thinn\$4 or grind\$4 or polish\$4 or buf\$5))) not (((438/\$.ccls. and warp\$4) and (thinn\$4 or grind\$4)) and ((dicing or cutt\$4 or singulat\$4 or separat\$4) near4 wafer)) not (438/460-465.ccls. and warp\$4)) or (438/460-465.ccls. and warp\$4) or (438/\$.ccls. and ((stress near2 balanc\$4) near3 (layer or film or substrate))) or (((438/113,114,460,464,465.ccls. and (thinn\$4 or grind\$\$ or polish\$4 or buf\$5)) and (warp\$4 or twist\$4 or deform\$6 or contort\$4)) not (((438/\$.ccls. and warp\$4) and (thinn\$4 or grind\$4)) and ((dicing or cutt\$4 or singulat\$4 or separat\$4) near4 wafer)) not (438/460-465.ccls. and warp\$4)) or (438/460-465.ccls. and warp\$4) or (438/\$.ccls. and ((stress near2 balanc\$4) near3 (layer or film or substrate))))))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/11 12:13
-	318	(438/460,464,465.ccls. and (thinn\$4 or grind\$\$ or polish\$4 or buf\$5)) not (((438/\$.ccls. and warp\$4) and (thinn\$4 or grind\$4)) and ((dicing or cutt\$4 or singulat\$4 or separat\$4) near4 wafer)) not (438/460-465.ccls. and warp\$4)) or (438/460-465.ccls. and warp\$4) or (438/\$.ccls. and ((stress near2 balanc\$4) near3 (layer or film or substrate))) or (((438/113,114,460,464,465.ccls. and (thinn\$4 or grind\$\$ or polish\$4 or buf\$5)) and (warp\$4 or twist\$4 or deform\$6 or contort\$4)) not (((438/\$.ccls. and warp\$4) and (thinn\$4 or grind\$4)) and ((dicing or cutt\$4 or singulat\$4 or separat\$4) near4 wafer)) not (438/460-465.ccls. and warp\$4)) or (438/460-465.ccls. and warp\$4) or (438/\$.ccls. and ((stress near2 balanc\$4) near3 (layer or film or substrate))))))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/11 12:14
-	633	438/113,114.ccls.	USPAT; US-PGPUB	2003/12/11 12:13

-	485	438/113,114.ccls. not (((((438/\$.ccls. and warp\$4) and (thinn\$4 or grind\$4)) and ((dicing or cutt\$4 or singulat\$4 or separat\$4) near4 wafer)) not (438/460-465.ccls. and warp\$4)) or (438/460-465.ccls. and warp\$4) or (438/\$.ccls. and ((stress near2 balanc\$4) near3 (layer or film or substrate))) or (((438/113,114,460,464,465.ccls. and (thinn\$4 or grind\$\$ or polish\$4 or buf\$5)) and (warp\$4 or twist\$4 or deform\$6 or contort\$4)) not (((((438/\$.ccls. and warp\$4) and (thinn\$4 or grind\$4)) and ((dicing or cutt\$4 or singulat\$4 or separat\$4) near4 wafer)) not (438/460-465.ccls. and warp\$4)) or (438/460-465.ccls. and warp\$4) or (438/\$.ccls. and ((stress near2 balanc\$4) near3 (layer or film or substrate))))) or ((438/460,464,465.ccls. and (thinn\$4 or grind\$\$ or polish\$4 or buf\$5)) not (((((438/\$.ccls. and warp\$4) and (thinn\$4 or grind\$4)) and ((dicing or cutt\$4 or singulat\$4 or separat\$4) near4 wafer)) not (438/460-465.ccls. and warp\$4)) or (438/460-465.ccls. and warp\$4) or (438/\$.ccls. and ((stress near2 balanc\$4) near3 (layer or film or substrate))) or (((438/113,114,460,464,465.ccls. and (thinn\$4 or grind\$\$ or polish\$4 or buf\$5)) and (warp\$4 or twist\$4 or deform\$6 or contort\$4)) not (((((438/\$.ccls. and warp\$4) and (thinn\$4 or grind\$4)) and ((dicing or cutt\$4 or singulat\$4 or separat\$4) near4 wafer)) not (438/460-465.ccls. and warp\$4)) or (438/460-465.ccls. and warp\$4) or (438/\$.ccls. and ((stress near2 balanc\$4) near3 (layer or film or substrate)))))))))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/11 12:14
-	148	(438/113,114.ccls. not (((((438/\$.ccls. and warp\$4) and (thinn\$4 or grind\$4)) and ((dicing or cutt\$4 or singulat\$4 or separat\$4) near4 wafer)) not (438/460-465.ccls. and warp\$4)) or (438/460-465.ccls. and warp\$4) or (438/\$.ccls. and ((stress near2 balanc\$4) near3 (layer or film or substrate))) or (((438/113,114,460,464,465.ccls. and (thinn\$4 or grind\$\$ or polish\$4 or buf\$5)) and (warp\$4 or twist\$4 or deform\$6 or contort\$4)) not (((((438/\$.ccls. and warp\$4) and (thinn\$4 or grind\$4)) and ((dicing or cutt\$4 or singulat\$4 or separat\$4) near4 wafer)) not (438/460-465.ccls. and warp\$4)) or (438/460-465.ccls. and warp\$4) or (438/\$.ccls. and ((stress near2 balanc\$4) near3 (layer or film or substrate))))) or ((438/460,464,465.ccls. and (thinn\$4 or grind\$\$ or polish\$4 or buf\$5)) not (((((438/\$.ccls. and warp\$4) and (thinn\$4 or grind\$4)) and ((dicing or cutt\$4 or singulat\$4 or separat\$4) near4 wafer)) not (438/460-465.ccls. and warp\$4)) or (438/460-465.ccls. and warp\$4) or (438/\$.ccls. and ((stress near2 balanc\$4) near3 (layer or film or substrate))) or (((438/113,114,460,464,465.ccls. and (thinn\$4 or grind\$\$ or polish\$4 or buf\$5)) and (warp\$4 or twist\$4 or deform\$6 or contort\$4)) not (((((438/\$.ccls. and warp\$4) and (thinn\$4 or grind\$4)) and ((dicing or cutt\$4 or singulat\$4 or separat\$4) near4 wafer)) not (438/460-465.ccls. and warp\$4)) or (438/460-465.ccls. and warp\$4) or (438/\$.ccls. and ((stress near2 balanc\$4) near3 (layer or film or substrate))))))))) and (thinn\$4 or grind\$4 or polish\$4 or buf\$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/11 12:14

-	22	(US-6037634-\$ or US-6544655-\$ or US-5521123-\$ or US-6426275-\$ or US-6451671-\$ or US-6562658-\$ or US-6297131-\$ or US-6656820-\$ or US-6593254-\$ or US-6156623-\$ or US-6642127-\$ or US-6303471-\$ or US-6136668-\$ or US-6025251-\$ or US-5650363-\$ or US-5641714-\$ or US-3874918-\$).did. or (US-20020048906-\$ or US-20020173077-\$ or US-20010042902-\$ or US-20030077878-\$ or US-20020123210-\$).did.	USPAT; US-PGPUB	2003/12/11 14:57
-	10	(US-6656820-\$ or US-6593254-\$ or US-6426275-\$ or US-6303471-\$ or US-6136668-\$ or US-6025251-\$).did. or (US-20020173077-\$ or US-20020123210-\$ or US-20020048906-\$ or US-20010042902-\$).did.	USPAT; US-PGPUB	2003/12/11 15:26
-	0	20020173077.URPN.	USPAT	2003/12/11 15:24
-	0	20020123210.URPN.	USPAT	2003/12/11 15:25
-	0	20020048906.URPN.	USPAT	2003/12/11 15:25
-	3	("6603191").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/11 15:26
-	9	("5155068" "5977641" "5989982" "6004833" "6157080" "6174751" "6180435" "6265783" "6321734").PN.	USPAT	2003/12/11 15:26
-	0	6603191.URPN.	USPAT	2003/12/11 15:27
-	9	("4626275" "5270261" "5455202" "5641714" "5888883" "5919713" "6110806" "6136668" "6391744").PN.	USPAT	2003/12/11 15:28
-	0	6656820.URPN.	USPAT	2003/12/11 15:29
-	12	("4404736" "5382551" "5599722" "5716873" "5780311" "5783850" "5801084" "5847463" "5856230" "5893760" "5958796" "6080675").PN.	USPAT	2003/12/11 15:29
-	6	("3861969" "4537244" "5160998" "5247557" "5448096" "5736226").PN.	USPAT	2003/12/11 15:30
-	5	5893760.URPN.	USPAT	2003/12/11 15:33
-	4	("4985745" "5071785" "5113236" "5183783").PN.	USPAT	2003/12/11 15:34
-	8	("4017341" "4581814" "5019529" "5071785" "5124561" "5226403" "5230184" "5234867").PN.	USPAT	2003/12/11 15:37
-	9	("3381182" "3462650" "3494809" "3566220" "3721588" "3798753" "3862852" "3925803" "3929528").PN.	USPAT	2003/12/11 15:38
-	28	4017341.URPN.	USPAT	2003/12/11 15:39
-	0	6593254.URPN.	USPAT	2003/12/11 15:42
-	5	("5637395" "5942578" "5960260" "6040204" "6342434").PN.	USPAT	2003/12/11 15:42
-	0	6426275.URPN.	USPAT	2003/12/11 15:43
-	10	("4908328" "5284803" "5445692" "5654226" "5851845" "5918113" "5994205" "6013534" "6077757" "6136668").PN.	USPAT	2003/12/11 15:43
-	1	6303471.URPN.	USPAT	2003/12/11 15:45
-	2	("3970819" "5552345").PN.	USPAT	2003/12/11 15:45
-	5	6136668.URPN.	USPAT	2003/12/11 15:46
-	9	("3701696" "3918150" "5040044" "5172195" "5250466" "5284781" "5349211" "5429954" "5923053").PN.	USPAT	2003/12/11 15:46
-	4	6025251.URPN.	USPAT	2003/12/11 15:47
-	15	(US-6656820-\$ or US-6593254-\$ or US-6426275-\$ or US-6303471-\$ or US-6136668-\$ or US-6025251-\$ or US-6603191-\$ or US-5893760-\$ or US-5801084-\$ or US-5382551-\$ or US-4017341-\$).did. or (US-20020173077-\$ or US-20020123210-\$ or US-20020048906-\$ or US-20010042902-\$).did.	USPAT; USPAT; US-PGPUB	2003/12/11 16:23
-	2	("20030162368").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/11 16:23

-	10	(US-6656820-\$ or US-6303471-\$ or US-6136668-\$ or US-6025251-\$ or US-6593254-\$ or US-6603191-\$ or US-5893760-\$).did. or (US-20030162368-\$ or US-20020173077-\$ or US-20020048906-\$).did.	USPAT; US-PGPUB	2004/04/19 09:51
-	150084	438/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/19 10:01
-	1244	438/\$.ccls. and (thinn\$4 near3 wafer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/19 10:09
-	3	(438/\$.ccls. and (thinn\$4 near3 wafer)) and ((stress near2 (balanc\$4 or supres\$5 or correct\$4 or regulat\$4 or equalizing)) near3 (layer or film or substrate))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/19 10:08
-	2586	438/460-465.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/19 10:09
-	148	438/460-465.ccls. and (thinn\$4 near3 wafer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/19 10:09
-	73	(438/460-465.ccls. and (thinn\$4 near3 wafer)) and (warp or stress)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/19 10:09
-	12	(US-6303471-\$ or US-6579748-\$ or US-6451671-\$ or US-5480842-\$ or US-6156623-\$ or US-5733814-\$ or US-4612408-\$ or US-3878008-\$).did. or (US-20020048906-\$ or US-20030215985-\$ or US-20030235937-\$ or US-20020177288-\$).did.	USPAT; US-PGPUB	2004/04/20 12:28
-	10	(US-6656820-\$ or US-6593254-\$ or US-6603191-\$ or US-6303471-\$ or US-6136668-\$ or US-5893760-\$ or US-6025251-\$).did. or (US-20020173077-\$ or US-20030162368-\$ or US-20020048906-\$).did.	USPAT; US-PGPUB	2004/04/20 12:29
-	6	("3861969" "4537244" "5160998" "5247557" "5448096" "5736226").PN.	USPAT	2004/04/20 14:16
-	5	5893760.URPN.	USPAT	2004/04/20 14:18
-	12	("4404736" "5382551" "5599722" "5716873" "5780311" "5783850" "5801084" "5847463" "5856230" "5893760" "5958796" "6080675").PN.	USPAT	2004/04/20 14:19
-	0	6593254.URPN.	USPAT	2004/04/20 14:23
-	0	20030162368.URPN.	USPAT	2004/04/20 14:24
-	11	(US-6579748-\$ or US-6303471-\$ or US-4612408-\$ or US-6656820-\$ or US-6603191-\$ or US-5893760-\$ or US-3861969-\$ or US-5856230-\$ or US-5801084-\$ or US-5780311-\$).did. or (US-20020048906-\$).did.	USPAT; US-PGPUB	2004/04/20 14:24
-	0	20020048906.URPN.	USPAT	2004/04/20 14:57
-	9	("4626275" "5270261" "5455202" "5641714" "5888883" "5919713" "6110806" "6136668" "6391744").PN.	USPAT	2004/04/20 14:57
-	0	6656820.URPN.	USPAT	2004/04/20 14:59
-	9	("5155068" "5977641" "5989982" "6004833" "6157080" "6174751" "6180435" "6265783" "6321734").PN.	USPAT	2004/04/20 14:59
-	0	6603191.URPN.	USPAT	2004/04/20 15:01
-	12	("5580466" "5661086" "5759269" "5786634" "5920769" "6001671" "6008070" "6096574" "6107164" "6140144" "6353267" "6391684").PN.	USPAT	2004/04/20 15:01

-	0	6579748.URPN.	USPAT	2004/04/20 15:03
-	10	("4908328" "5284803" "5445692" "5654226" "5851845" "5918113" "5994205" "6013534" "6077757" "6136668").PN.	USPAT	2004/04/20 15:04
-	2	6303471.URPN.	USPAT	2004/04/20 15:05
-	6	("3861969" "4537244" "5160998" "5247557" "5448096" "5736226").PN.	USPAT	2004/04/20 15:07
-	5	5893760.URPN.	USPAT	2004/04/20 15:07
-	1	"5212111".PN.	USPAT	2004/04/20 15:07
-	5	5856230.URPN.	USPAT	2004/04/20 15:07
-	4	("4985745" "5071785" "5113236" "5183783").PN.	USPAT	2004/04/20 15:09
-	15	5801084.URPN.	USPAT	2004/04/20 15:10
-	7	("3966577" "5049968" "5071785" "5084408" "5113236" "5183783" "5276338").PN.	USPAT	2004/04/20 15:12
-	14	5780311.URPN.	USPAT	2004/04/20 15:13
-	14	5780311.URPN.	USPAT	2004/04/20 15:32
-	3	("4131984" "4179318" "4456782").PN.	USPAT	2004/04/20 15:32
-	29	4612408.URPN.	USPAT	2004/04/20 15:32
-	2	("3580745" "3629018").PN.	USPAT	2004/04/20 15:36
-	7	3861969.URPN.	USPAT	2004/04/20 15:36
-	150210	438/\$.cccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/20 16:37
-	550	438/\$.cccls. and (reduc\$4 with warp\$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/20 16:38
-	11	(US-6303471-\$ or US-6579748-\$ or US-4612408-\$ or US-6603191-\$ or US-6656820-\$ or US-5893760-\$ or US-3861969-\$ or US-5801084-\$ or US-5856230-\$ or US-5780311-\$).did. or (US-20020048906-\$).did.	USPAT; US-PGPUB	2004/04/26 09:00
-	11	(US-6303471-\$ or US-6579748-\$ or US-4612408-\$ or US-6603191-\$ or US-6656820-\$ or US-5893760-\$ or US-3861969-\$ or US-5801084-\$ or US-5856230-\$ or US-5780311-\$).did. or (US-20020048906-\$).did.	USPAT; US-PGPUB	2004/04/26 11:39
-	8	(US-6579748-\$ or US-6303471-\$ or US-5893760-\$ or US-5856230-\$ or US-3861969-\$ or US-6656820-\$ or US-6603191-\$).did. or (US-20020048906-\$).did.	USPAT; US-PGPUB	2004/04/26 12:38
-	23	US-2357600-\$.DID. OR US-2413767-\$.DID. OR US-2454548-\$.DID. OR US-2495541-\$.DID. OR US-3254776-\$.DID. OR US-3327889-\$.DID. OR US-3625384-\$.DID. OR US-3628672-\$.DID. OR US-3751587-\$.DID. OR US-3774352-\$.DID. OR US-0379907-\$.DID. OR US-0383750-\$.DID. OR US-3887997-\$.DID. OR US-3903934-\$.DID. OR US-3937386-\$.DID. OR US-3969813-\$.DID. OR US-3973665-\$.DID. OR US-4024545-\$.DID. OR US-4027246-\$.DID. OR US-4030622-\$.DID. OR US-4058217-\$.DID. OR US-4095095-\$.DID. OR US-0409776-\$.DID.	USPAT	2004/04/26 12:42
-	23	US-0423044-\$.DID. OR US-4148057-\$.DID. OR US-4178531-\$.DID. OR US-4203486-\$.DID. OR US-4285433-\$.DID. OR US-4323755-\$.DID. OR US-4346284-\$.DID. OR US-0435267-\$.DID. OR US-4353796-\$.DID. OR US-4354770-\$.DID. OR US-47370542-\$.DID. OR US-4375025-\$.DID. OR US-4382580-\$.DID. OR US-0440334-\$.DID. OR US-0445443-\$.DID. OR US-4461073-\$.DID. OR US-4493767-\$.DID. OR US-4510673-\$.DID. OR US-0453539-\$.DID. OR US-0457436-\$.DID. OR US-0452339-\$.DID. OR US-4534695-\$.DID. OR US-4539878-\$.DID. OR US-0455221-\$.DID.	USPAT	2004/04/26 12:44

-	26	US-4585931-\$.DID. OR US-4594263-\$.DID. OR US-4607744-\$.DID. OR US-4610359-\$.DID. OR US-4616414-\$.DID. OR US-4626656-\$.DID. OR US-4630513-\$.DID. OR US-0463844-\$.DID. OR US-0464426-\$.DID. OR US-4654290-\$.DID. OR US-4660282-\$.DID. OR US-4677370-\$.DID. OR US-4665298-\$.DID. OR US-4696096-\$.DID. OR US-4702788-\$.DID. OR US-4707722-\$.DID. OR US-4718531-\$.DID. OR US-0472037-\$.DID. OR US-4749631-\$.DID. OR US-4753863-\$.DID. OR US-4756977-\$.DID. OR US-4759675-\$.DID. OR US-4767984-\$.DID. OR US-4769345-\$.DID. OR US-4772079-\$.DID. OR US-4778326-\$.DID.	USPAT	2004/04/26 12:49
-	26	US-4778326-\$.DID. OR US-4790515-\$.DID. OR US-0791267-\$.DID. OR US-0488835-\$.DID. OR US-0482151-\$.DID. OR US-0483262-\$.DID. OR US-4850780-\$.DID. OR US-4861620-\$.DID. OR US-4884420-\$.DID. OR US-4891242-\$.DID. OR US-4914269-\$.DID. OR US-4926677-\$.DID. OR US-4944492-\$.DID. OR US-4945204-\$.DID. OR US-0494791-\$.DID. OR US-4965927-\$.DID. OR US-4967260-\$.DID. OR US-4990051-\$.DID. OR US-5003251-\$.DID. OR US-0501459-\$.DID. OR US-0508938-\$.DID. OR US-5020959-\$.DID. OR US-5030551-\$.DID. OR US-5043657-\$.DID. OR US-5090664-\$.DID. OR US-5102291-\$.DID.	USPAT	2004/04/26 13:13
-	23	US-0527837-\$.DID. OR US-0528737-\$.DID. OR US-5148969-\$.DID. OR US-0550797-\$.DID. OR US-0577368-\$.DID. OR US-0597650-\$.DID. OR US-0520343-\$.DID. OR US-5204987-\$.DID. OR US-5206280-\$.DID. OR US-5218894-\$.DID. OR US-0529765-\$.DID. OR US-5220754-\$.DID. OR US-5226361-\$.DID. OR US-0524566-\$.DID. OR US-5245900-\$.DID. OR US-5256578-\$.DID. OR US-5260542-\$.DID. OR US-5262470-\$.DID. OR US-5263567-\$.DID. OR US-5268059-\$.DID. OR US-5278442-\$.DID. OR US-5279975-\$.DID. OR US-0528913-\$.DID.	USPAT	2004/04/26 13:16
-	2	("5203143").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/26 13:16
-	26	US-0529034-\$.DID. OR US-5295778-\$.DID. OR US-5299902-\$.DID. OR US-0530143-\$.DID. OR US-5302798-\$.DID. OR US-5307010-\$.DID. OR US-0531356-\$.DID. OR US-0535094-\$.DID. OR US-0532273-\$.DID. OR US-5323051-\$.DID. OR US-5329090-\$.DID. OR US-5332463-\$.DID. OR US-5335458-\$.DID. OR US-5336928-\$.DID. OR US-5346802-\$.DID. OR US-5357077-\$.DID. OR US-5360747-\$.DID. OR US-5365653-\$.DID. OR US-5373039-\$.DID. OR US-5375320-\$.DID. OR US-5379514-\$.DID. OR US-5399828-\$.DID. OR US-5402563-\$.DID. OR US-5413629-\$.DID. OR US-5417408-\$.DID. OR US-0542376-\$.DID.	USPAT	2004/04/26 13:18

-	26	US-5290134-\$.DID. OR US-5295778-\$.DID. OR US-5299902-\$.DID. OR US-5301143-\$.DID. OR US-5302798-\$.DID. OR US-5307010-\$.DID. OR US-5313156-\$.DID. OR US-5315094-\$.DID. OR US-5322173-\$.DID. OR US-5323051-\$.DID. OR US-5329090-\$.DID. OR US-5332463-\$.DID. OR US-5335458-\$.DID. OR US-5336928-\$.DID. OR US-5346802-\$.DID. OR US-5357077-\$.DID. OR US-5360747-\$.DID. OR US-5365653-\$.DID. OR US-5373039-\$.DID. OR US-5375320-\$.DID. OR US-5379514-\$.DID. OR US-5399828-\$.DID. OR US-5402563-\$.DID. OR US-5413629-\$.DID. OR US-5417408-\$.DID. OR US-5423716-\$.DID.	USPAT	2004/04/26 13:22
-	27	US-5423931-\$.DID. OR US-5427349-\$.DID. OR US-5445923-\$.DID. OR US-5455459-\$.DID. OR US-5454900-\$.DID. OR US-5448488-\$.DID. OR US-5458158-\$.DID. OR US-5463227-\$.DID. OR US-5465470-\$.DID. OR US-5466908-\$.DID. OR US-5467023-\$.DID. OR US-5479694-\$.DID. OR US-5481202-\$.DID. OR US-5484314-\$.DID. OR US-5487471-\$.DID. OR US-5496432-\$.DID. OR US-5497033-\$.DID. OR US-5498851-\$.DID. OR US-5534094-\$.DID. OR US-5545367-\$.DID. OR US-5547906-\$.DID. OR US-5551959-\$.DID. OR US-5566414-\$.DID. OR US-5566840-\$.DID. OR US-5587094-\$.DID. OR US-5588797-\$.DID. OR US-5590787-\$.DID.	USPAT	2004/04/26 13:50
-	26	US-5600150-\$.DID. OR US-5600181-\$.DID. OR US-5605641-\$.DID. OR US-5629484-\$.DID. OR US-5632083-\$.DID. OR US-5632915-\$.DID. OR US-5635766-\$.DID. OR US-5638958-\$.DID. OR US-5643477-\$.DID. OR US-5648436-\$.DID. OR US-5653900-\$.DID. OR US-5654204-\$.DID. OR US-5656548-\$.DID. OR US-5665609-\$.DID. OR US-5682065-\$.DID. OR US-5691544-\$.DID. OR US-5692873-\$.DID. OR US-5715592-\$.DID. OR US-5719372-\$.DID. OR US-5722639-\$.DID. OR US-5765277-\$.DID. OR US-5793051-\$.DID. OR US-5801067-\$.DID. OR US-5805472-\$.DID. OR US-5808268-\$.DID. OR US-5821497-\$.DID.	USPAT	2004/04/26 13:55
-	27	US-5829115-\$.DID. OR US-5838361-\$.DID. OR US-5838431-\$.DID. OR US-5840614-\$.DID. OR US-5844803-\$.DID. OR US-5856923-\$.DID. OR US-5866644-\$.DID. OR US-5870820-\$.DID. OR US-5875544-\$.DID. OR US-5903044-\$.DID. OR US-5907492-\$.DID. OR US-5909706-\$.DID. OR US-5911461-\$.DID. OR US-5915231-\$.DID. OR US-5927512-\$.DID. OR US-5928842-\$.DID. OR US-5932119-\$.DID. OR US-5937270-\$.DID. OR US-5942136-\$.DID. OR US-5946791-\$.DID. OR US-5962097-\$.DID. OR US-5966307-\$.DID. OR US-5976955-\$.DID. OR US-5985377-\$.DID. OR US-5985510-\$.DID. OR US-5986235-\$.DID. OR US-5991245-\$.DID.	USPAT	2004/04/26 14:05
-	2	("5999252").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/26 14:05

-	18	US-6008070-\$.DID. OR US-6008476-\$.DID. OR US-6023042-\$.DID. OR US-6028134-\$.DID. OR US-6030485-\$.DID. OR US-6048624-\$.DID. OR US-6062119-\$.DID. OR US-6070731-\$.DID. OR US-6084288-\$.DID. OR US-6100486-\$.DID. OR US-6122563-\$.DID. OR US-6138542-\$.DID. OR US-5153034-\$.DID. OR US-6154366-\$.DID. OR US-6202292-\$.DID. OR US-6229323-\$.DID. OR US-6244569-\$.DID. OR US-6244634-\$.DID. OR US-6287068-\$.DID.	USPAT	2004/04/26 14:09
-	2	("6188129").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/26 14:10
-	2	("5153034").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/26 14:10
-	2	("6137125").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/26 14:11
-	4	((("6108026") or ("6113992"))).PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/26 14:15
-	1	("6048624").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/26 14:16
-	2	("6011315").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/26 17:02
-	1	("20030162368").PN.	US-PGPUB	2004/04/26 17:03
-	8	(US-6603191-\$ or US-6656820-\$ or US-6579748-\$ or US-6303471-\$ or US-5856230-\$ or US-5893760-\$ or US-3861969-\$.did. or (US-20020048906-\$.did.	USPAT; US-PGPUB	2004/04/27 15:35